

### SE50PAB, SE50PAD, SE50PAG, SE50PAJ

Vishay General Semiconductor

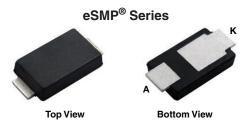
AUTOMOTIVE

COMPLIANT

HALOGEN

FREE

# **Surface-Mount ESD Capability Rectifiers**



SMPA (DO-221BC)

Anode O Cathode

#### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS                  |                            |  |  |  |  |
|--|----------------------------|--|--|--|--|
| I <sub>F(AV)</sub>                       | 5.0 A                      |  |  |  |  |
| V <sub>RRM</sub>                         | 100 V, 200 V, 400 V, 600 V |  |  |  |  |
| I <sub>FSM</sub>                         | 42 A                       |  |  |  |  |
| $V_F$ at $I_F = 5.0$ A ( $T_A = 125$ °C) | 0.95 V                     |  |  |  |  |
| I <sub>R</sub>                           | 10 μΑ                      |  |  |  |  |
| T <sub>J</sub> max.                      | 175 °C                     |  |  |  |  |
| Package                                  | SMPA (DO-221BC)            |  |  |  |  |
| Circuit configuration                    | Single                     |  |  |  |  |

### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

General purpose, power line polarity protection, in both consumer and automotive applications.

#### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                   |                                   |             |         |         |         |      |
|---|-----------------------------------|-------------|---------|---------|---------|------|
| PARAMETER   | SYMBOL                            | SE50PAB     | SE50PAD | SE50PAG | SE50PAJ | UNIT |
| Device marking code   |                                   | 50B         | 50D     | 50G     | 50J     |      |
| Maximum repetitive peak reverse voltage   | V <sub>RRM</sub>                  | 100         | 200     | 400     | 600     | V    |
| Maximum DC forward current  | I <sub>F</sub> <sup>(1)</sup>     | 5.0         |         |         |         | Α    |
| Maximum DC forward current  | I <sub>F</sub> <sup>(2)</sup>     | 1.6         |         |         |         |      |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                  | 42          |         |         | Α       |      |
| Operating junction and storage temperature range                                  | T <sub>J</sub> , T <sub>STG</sub> | -55 to +175 |         |         | °C      |      |

### **Notes**

(1) Mounted on 30 mm x 30 mm pad areas, aluminum PCB

(2) Free air, mounted on recommended copper pad area

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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |  |                         |                               |      |      |      |  |
|---|--|-------------------------|-------------------------------|------|------|------|--|
| PARAMETER   | TEST (   | CONDITIONS              | SYMBOL                        | TYP. | MAX. | UNIT |  |
| Instantaneous forward voltage   | I <sub>F</sub> = 2.5 A   | T <sub>A</sub> = 25 °C  |                               | 0.94 | =    | V    |  |
|   | I <sub>F</sub> = 5.0 A   |                         | V <sub>E</sub> (1)            | 1.03 | 1.16 |      |  |
|   | I <sub>F</sub> = 2.5 A   | T <sub>A</sub> = 125 °C | □ VF(')                       | 0.84 | -    |      |  |
|   | I <sub>F</sub> = 5.0 A   |                         |                               | 0.95 | 1.10 |      |  |
| Reverse current   | Rated V <sub>R</sub>   | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | =    | 10   | μΑ   |  |
|   | nateu v <sub>R</sub>   | T <sub>A</sub> = 125 °C | IR (-)                        | 13   | 150  |      |  |
| Typical reverse recovery time   | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A |                         | t <sub>rr</sub>               | 2.0  | -    | μs   |  |
| Typical junction capacitance  | 4.0 V, 1 MHz   |                         | CJ                            | 32   | -    | pF   |  |

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq$  40 ms

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted) |                      |     |  |  |      |      |
|---|----------------------|-----|--|--|------|------|
| PARAMETER SYMBOL SE50PAB SE50PAG SE50PAJ U                              |                      |     |  |  | UNIT |      |
| Typical thormal registance  |                      | 115 |  |  |      | °C/W |
| Typical thermal resistance  | R <sub>0JM</sub> (2) | 7   |  |  | C/VV |      |

#### Notes

 $^{(1)}\,$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(2)}$  Mounted on 30 mm x 30 mm pad areas aluminum PCB;  $R_{\theta JM}$  - junction to mount

| IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25~^{\circ}\text{C}$ unless otherwise noted) |   |                          |                |     |        |  |
|--|---|--------------------------|----------------|-----|--------|--|
| STANDARD   | ANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS V |                          |                |     | VALUE  |  |
| AEC-Q101-001   | Human body model (contact mode)                 | C = 100  pF, R = 1.5  kΩ | V <sub>C</sub> | НЗВ | > 8 kV |  |

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |  |
| SE50PAJ-M3/I                   | 0.033           | 1                      | 14 000        | 13" diameter plastic tape and reel |  |  |
| SE50PAJHM3/H (1)               | 0.033           | Н                      | 3500          | 7" diameter plastic tape and reel  |  |  |
| SE50PAJHM3/I (1)               | 0.033           | I                      | 14 000        | 13" diameter plastic tape and reel |  |  |

#### Note

(1) AEC-Q101 qualified





6.5

6.0

5.5

5.0 4.5 4.0

3.5

3.0 2.5 2.0 1.5 1.0 0.5 0.0

Average Power Loss (W)

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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

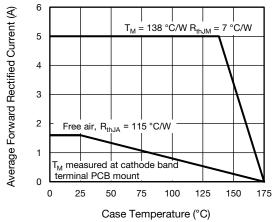
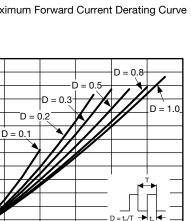


Fig. 1 - Maximum Forward Current Derating Curve



Average Forward Current (A) Fig. 2 - Forward Power Loss Characteristics

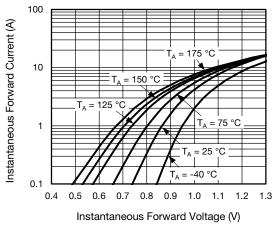


Fig. 3 - Typical Instantaneous Forward Characteristics

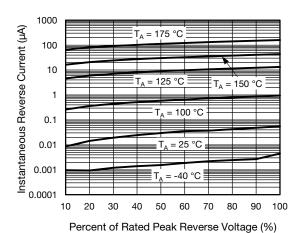


Fig. 4 - Typical Reverse Leakage Characteristics

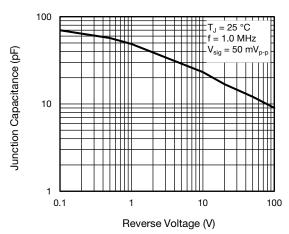


Fig. 5 - Typical Junction Capacitance

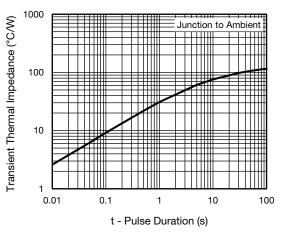


Fig. 6 - Typical Transient Thermal Impedances

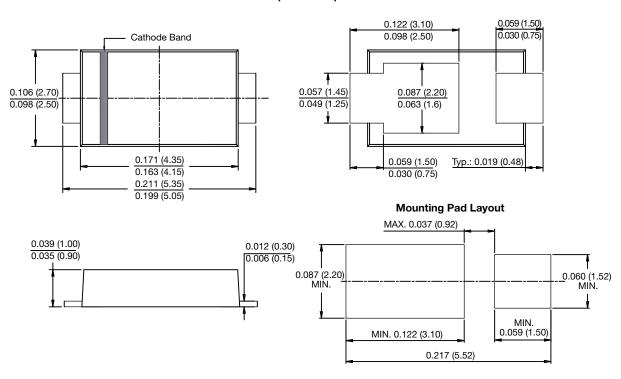


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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### **SMPA (DO-221BC)**



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